Signetics

FAST 74F273
Flip-Flop

FAST Products

Octal D Flip-Flop
Product Specification

FEATURES

- **High impedance NPN base inputs for reduced loading (20μA in Low and High states)**
- **Ideal buffer for MOS microprocessor or memory**
- **Eight edge-triggered D-type flip-flops**
- **Buffered common clock**
- **Buffered asynchronous Master Reset**
- **See 'F377 for clock enable version**
- **See 'F373 for transparent latch version**
- **See 'F374 for 3-state version**

TYPE	TYPICAL f_{MAX}	TYPICAL SUPPLY CURRENT (TOTAL)
74F273	125MHz	66mA

ORDERING INFORMATION

PACKAGES	COMMERCIAL RANGE V_{CC} = 5V±10%; T_A = 0°C to +70°C
20-Pin Plastic DIP	N74F273N
20-Pin Plastic SOL	N74F273D

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
D_0 - D_7	Data inputs	1.0/0.033	20μA/20μA
$\overline{MR}$	Master Reset input (active Low)	1.0/0.033	20μA/20μA
CP	Clock Pulse input (active rising edge)	1.0/0.033	20 A/20 A
Q_0 - Q_7	Data outputs	50/33	1.0mA/20mA

NOTE:
One (1.0) FAST Unit Load is defined as: 20μA in the High state and 0.6mA in the Low state.

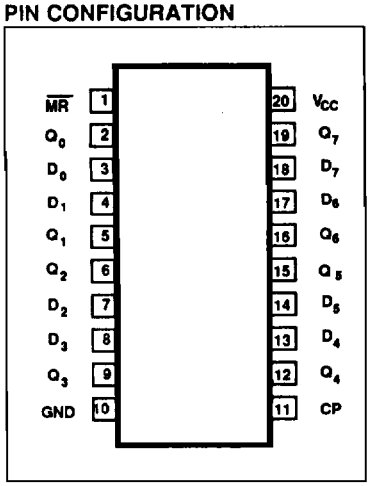
DESCRIPTION

The 74F273 has eight edge-triggered D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) and Master Reset ($\overline{MR}$) inputs load and reset (clear) all flip-flops simultaneously.

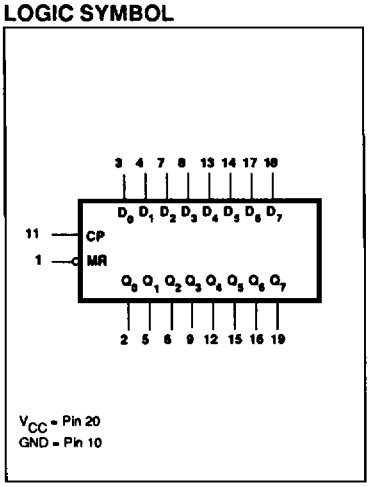
The register is fully edge-triggered. The state of each D input, one setup time before the Low-to-High clock transition, is transferred to the corresponding flip-flop's Q output.

All outputs will be forced Low independently of Clock or Data inputs by a Low voltage level on the $\overline{MR}$ input. The device is useful for applications where the true output only is required and the CP and $\overline{MR}$ are common to all elements.

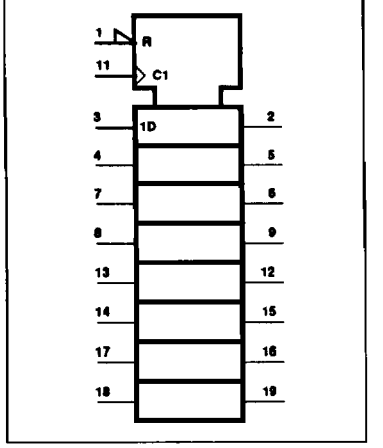
PIN CONFIGURATION



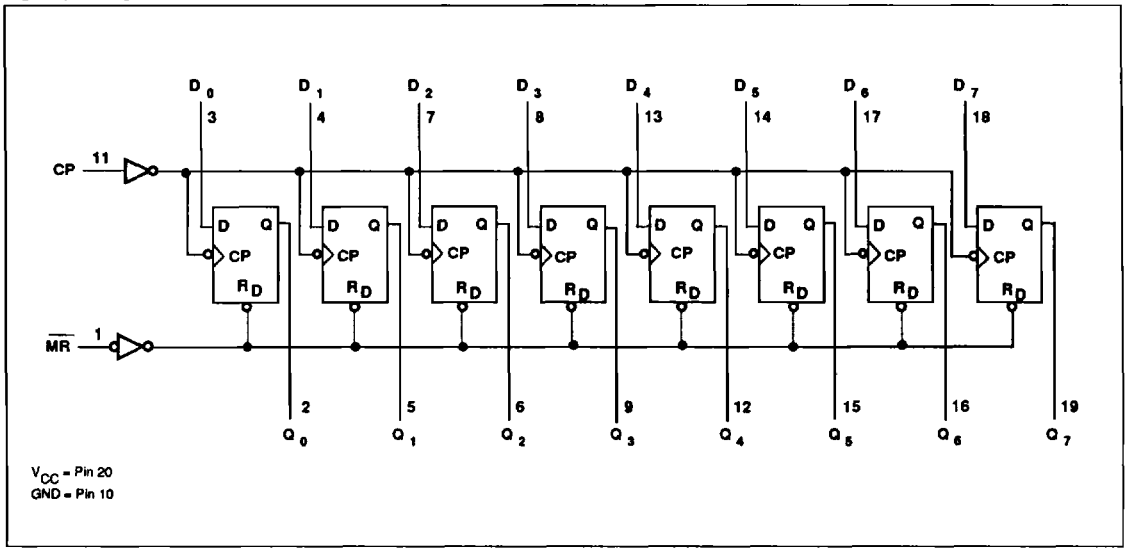
LOGIC SYMBOL



LOGIC SYMBOL(IEEE/IEC)



LOGIC DIAGRAM



FUNCTION TABLE

INPUTS			OUTPUTS	OPERATING MODE
$\overline{MR}$	CP	D_n	Q_0 - Q_7	
L	X	X	L	Reset (clear)
H	↑	h	H	Load "1"
H	↑	l	L	Load "0"

H = High voltage level
h = High voltage level one set-up time prior to the Low-to-High clock transition
L = Low voltage level
l = Low voltage level one set-up time prior to the Low-to-High clock transition
X = Don't care
↑ = Low-to-High clock transition

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V_{CC}	Supply voltage	-0.5 to +7.0	V
V_{IN}	Input voltage	-0.5 to +7.0	V
I_{IN}	Input current	-30 to +5	mA
V_{OUT}	Voltage applied to output in High output state	-0.5 to +V_{CC}	V
I_{OUT}	Current applied to output in Low output state	40	mA
T_A	Operating free-air temperature range	0 to +70	°C
T_{STG}	Storage temperature	-65 to +150	°C

RECOMMENDED OPERATION CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		Min	Nom	Max	
V_{CC}	Supply voltage	4.5	5.0	5.5	V
V_{IH}	High-level input voltage	2.0			V
V_{IL}	Low-level input voltage			0.8	V
I_{IK}	Input clamp current			-18	mA
I_{OH}	High-level output current			-1	mA
I_{OL}	Low-level output current			20	mA
T_A	Operating free-air temperature range	0		70	°C

DC ELECTRICAL CHARACTERISTICS (Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS[1]		LIMITS			UNIT
					Min	Typ[2]	Max	
V_{OH}	High-level output voltage	$\overline{MR}$ &CP inputs	V_{CC} = MIN, V_{IL} = 0.0V,[3] V_{IH} = 4.5V,[3] I_{OH} = MAX	±10%V_{CC}	2.5			V
				±5%V_{CC}	2.7	3.4		V
		other inputs	V_{CC} = MIN, V_{IL} = MAX V_{IH} = MIN, I_{OH} = MAX	±10%V_{CC}	2.5			V
				±5%V_{CC}	2.7	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IL} = MAX V_{IH} = MIN, I_{OL} = MAX	±10%V_{CC}		0.30	0.50	V
				±5%V_{CC}		0.30	0.50	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = I_{IK}			-0.73	-1.2	V
I_I	Input current at maximum input voltage		V_{CC} = 0.0V, V_I = 7.0V				100	µA
I_{IH}	High-level input current		V_{CC} = MAX, V_I = 2.7V				20	µA
I_{IL}	Low-level input current		V_{CC} = MAX, V_I = 0.5V				-20	µA
I_{OS}	Short circuit output current[4]		V_{CC} = MAX		-60		-150	mA
I_{CC}	Supply current (total)	I_{CCH}	V_{CC} = MAX			65	85	mA
		I_{CCL}				68	88	mA

NOTES:
1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
2. All typical values are at V_{CC} = 5V, T_A = 25°C.
3. To reduce the effect of external noise during test.
4. Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

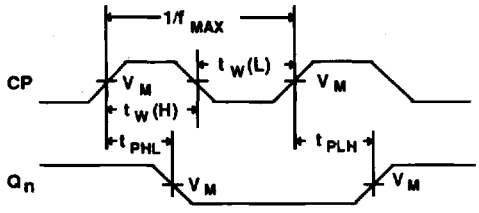
AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS					UNIT
			T_A = +25°C, V_{CC} = 5V, C_L = 50pF, R_L = 500Ω			T_A = 0°C to +70°C, V_{CC} = 5V ±10%, C_L = 50pF, R_L = 500Ω		
			Min	Typ	Max	Min	Max	
f_{MAX}	Maximum clock frequency	Waveform 1	115	125		100		MHz
t_{PLH} t_{PHL}	Propagation delay CP_n to Q_n	Waveform 1	4.0 4.0	7.5 7.5	9.5 9.5	4.0 4.0	10.5 10.5	ns
t_{PHL}	Propagation delay $\overline{MR}$ to Q_n	Waveform 2	4.0	5.5	8.5	3.5	9.0	ns

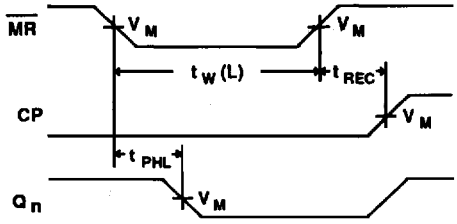
AC SETUP REQUIREMENTS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS					UNIT
			T_A = +25°C, V_{CC} = 5V, C_L = 50pF, R_L = 500Ω			T_A = 0°C to +70°C, V_{CC} = 5V ±10%, C_L = 50pF, R_L = 500Ω		
			Min	Typ	Max	Min	Max	
$t_s(H)$ $t_s(L)$	Setup time, High or Low D_n to CP	Waveform 3	3.0 3.0			3.0 3.0		ns
$t_h(H)$ $t_h(L)$	Hold time, High or Low D_n to CP	Waveform 3	0.0 0.0			0.0 0.0		ns
$t_w(H)$ $t_w(L)$	CP Pulse width, High or Low	Waveform 1	4.0 5.0			4.0 5.5		ns
$t_w(L)$	Master Reset Pulse width, Low	Waveform 2	3.5			4.5		ns
t_{REC}	Recovery time $\overline{MR}$ to CP	Waveform 2	8.5			9.0		ns

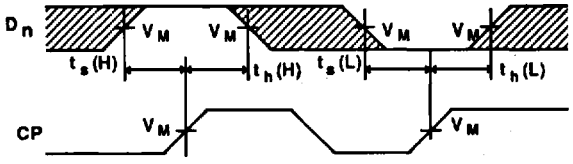
AC WAVEFORMS



Waveform 1. Propagation Delay, Clock Input To Output, Clock Pulse Width, and Maximum Clock Frequency



Waveform 2. Master Reset Pulse Width, Master Reset to Output Delay and Master Reset to Clock Recovery Time

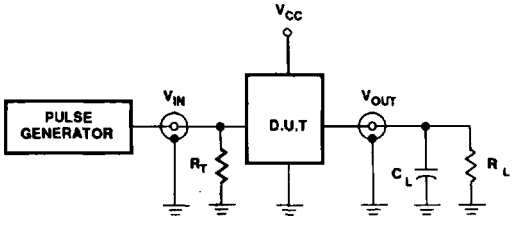


Waveform 3. Data Setup And Hold Times

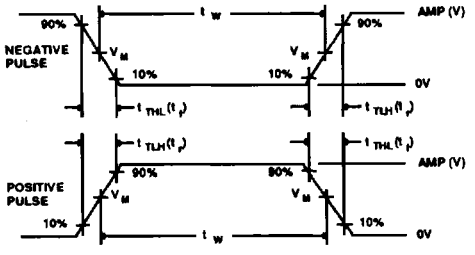
NOTE: For all waveforms, V_M = 1.5V.

The shaded areas indicate when the input is permitted to change for predictable output performance.

TEST CIRCUIT AND WAVEFORMS



Test Circuit For Totem-Pole Outputs



V_M = 1.5V

Input Pulse Definition

FAMILY	INPUT PULSE REQUIREMENTS				
	Amplitude	Rep. Rate	t_W	t_{TLH}	t_{THL}
74F	3.0V	1MHz	500ns	2.5ns	2.5ns

DEFINITIONS

R_L = Load resistor; see AC CHARACTERISTICS for value.

C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.